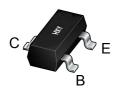


#### **FEATURES**

• Complimentary to S8550

• Collector Current: I<sub>C</sub>=0.5A

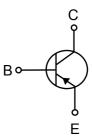
Power Dissipation of 300mw



**SOT-23** 

# **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)
S8550	SOT-23	2TY	3000



## MAXIMUM RATINGS (Ta=25 unless otherwise noted)

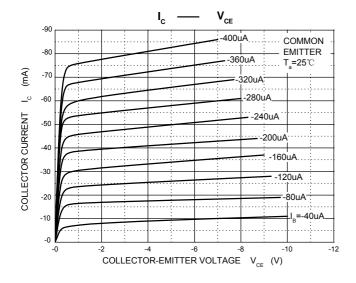
Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-40	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-25	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5	V
Collector Current	I <sub>c</sub>	-500	mA
Collector Power Dissipation	P <sub>c</sub>	300	mW
Thermal Resistance From Junction To Ambient	R <sub>OJA</sub>	421	°CM
Junction Temperature	T <sub>j</sub>	150	℃
Storage Temperature	T <sub>stg</sub>	-55∼+150	℃

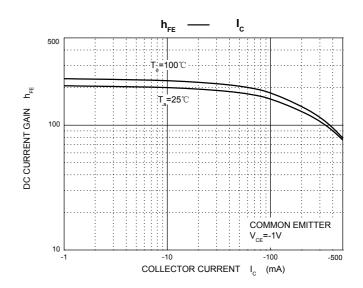


## ELECTRICAL CHARACTERISTICS (Ta=25 unless otherwise specified)

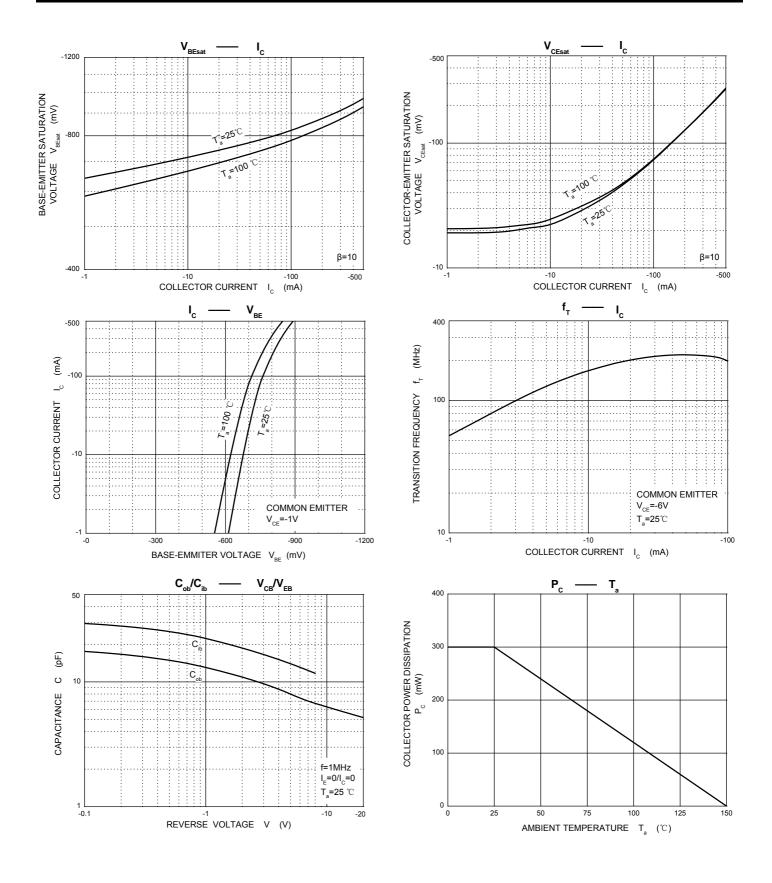
Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> = -100μΑ, I <sub>E</sub> =0	-40		V
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> =-1mA, I <sub>B</sub> =0	-25		V
Emitter-base breakdown voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> = -100μA, I <sub>C</sub> =0	-5		V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -40V, I <sub>E</sub> =0		-0.1	μA
Collector cut-off current	I <sub>CEO</sub>	V <sub>CE</sub> = -20V, I <sub>B</sub> =0		-0.1	μA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -3V, I <sub>C</sub> =0		-0.1	μA
DC comment main	h <sub>FE(1)</sub>	V <sub>CE</sub> = -1V, I <sub>C</sub> = -50mA	120	400	
DC current gain	h <sub>FE(2)</sub>	V <sub>CE</sub> = -1V, I <sub>C</sub> = -500mA	50		
Collector-emitter saturation voltage	V <sub>CE</sub> (sat)	I <sub>C</sub> =-500mA, I <sub>B</sub> = -50mA		-0.6	V
Base-emitter saturation voltage	V <sub>BE</sub> (sat)	I <sub>C</sub> =-500mA, I <sub>B</sub> = -50mA		-1.2	٧
Transition frequency	f⊤	V <sub>CE</sub> = -6V, I <sub>C</sub> = -20mA f=30MHz	150		MHz

### **Typical Characteristics**

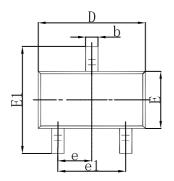


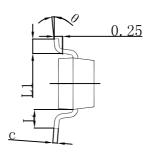


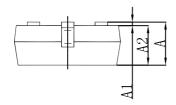




## **SOT-23 Package Outline Dimensions**

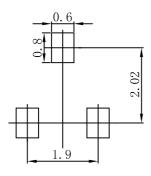






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950	0.950 TYP 0.037		7 TYP	
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

## **SOT-23 Suggested Pad Layout**



- Note:
  1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
  3.The pad layout is for reference purposes only.



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